

04-26-1999

HEET

To the Honorable Commissioner of

hed original documents or copy thereof.

101020625

1. Name of conveying party(ies):

**Thad McMillan
Gita Khadem**

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

3. Nature of Conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: _____

2. Name and address of receiving party(ies):

Name: Dell USA, L.P.Internal Address: One Dell WayStreet Address: SAMECity: Round Rock State: Texas ZIP: 78682-2241Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If the document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David L. McCombsInternal Address: 901 Main Street, Suite 3100Street Address: SAMECity: Dallas State: Texas ZIP: 75202-3789

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41)

\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit Account Number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and Signature.

To the best of my knowledge and belief the foregoing information is true and correct and any attached copy is a true copy of the original document.

04/22/1999 DFLOYD 00000015 09291766

04 FC:501

David L. McCombs

Name of Person Signing

Signature

Date

Total Number of Pages Comprising Cover Sheet

3

Do not detach this portion

Mail documents to be recorded with required cover sheet information to:

**Commissioner of Patents and Trademarks
Box Assignments
Washington, D.C. 20231**

Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, including time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-1000 Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (065-0011), Washington, D.C. 20503.

Published by THE BUREAU OF NATIONAL AFFAIRS, INC., Washington, D.C. 20037

ASSIGNMENT

WHEREAS, WE,

- | | | |
|-----|---------------|----------------------------------|
| (1) | Thad McMillan | City of Austin
State of Texas |
| (2) | Gita Khadem | City of Austin
State of Texas |

have invented certain improvements in a


**PRINTED CIRCUIT BOARD AND METHOD FOR EVALUATING THE
INNER LAYER HOLE REGISTRATION PROCESS CAPABILITY OF
THE PRINTED CIRCUIT BOARD MANUFACTURING PROCESS**

and executed a United States patent application filed herewith.


WHEREAS, DELL USA, L.P., a Texas limited partnership having a place of business at One Dell Way, Round Rock, TX 78682-2244 (hereinafter called DELL), desires to acquire the entire right, title and interest in the application and invention, and to any United States and foreign patents to be obtained therefor;

NOW, THEREFORE, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby acknowledge our prior existing obligation and hereby sell, assign, and transfer to DELL, its successors and assigns, the entire right, title, and interest in the application and invention therein disclosed for the United States and foreign countries, to and under the said improvements, and the said application and all divisional, renewals, continuing applications thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in the application to DELL its successors and assigns; and we hereby agree that DELL may apply for foreign Letters Patent on the invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by DELL.

(1) 4-12-99
Date


Thad McMillan

(2) 4-12-99
Date


Gita Khadem

a-80675.1